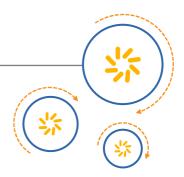


RF360 Europe GmbH
A Qualcomm – TDK Joint Venture



# **SAW** components

## SAW filter

Small cell & femtocell Beidou B1; GPS; GLONASS

Series/type: B9621

Ordering code: B39162B9621P810

Date: May 16, 2017

Version: 2.2

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SAW filter 1582.47 MHz

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SAW filter 1582.47 MHz

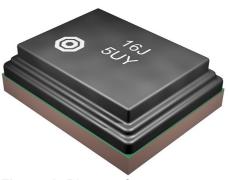
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#### 1 Application

- Low-loss RF GPS + Beidou B1 + GLONASS filter for industrial electronics
- Simultaneous usage of GPS, Beidou B1 and GLONASS Bands
- Usable pass band: 2.0 MHz for GPS, 4.092 MHz for Beidou B1 and 8.34 MHz for GLONASS
- Very low insertion attenuation
- $\blacksquare$  No matching network required for operation at 50  $\Omega$

#### 2 Features

- Package size 1.4±0.1 mm × 1.1±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)



**Figure 1:** Picture of component with example of product marking.

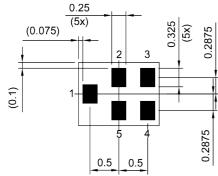


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#### 3 Package

**BOTTOM VIEW** 



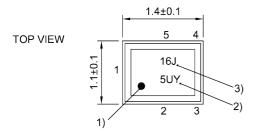
Pad and pitch tolerance ±0.05

### 4 Pin configuration

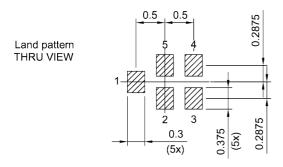
- 1 Input
- 4 Output
- 2, 3, 5 Ground

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

**Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 18).



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#### 5 Matching circuit

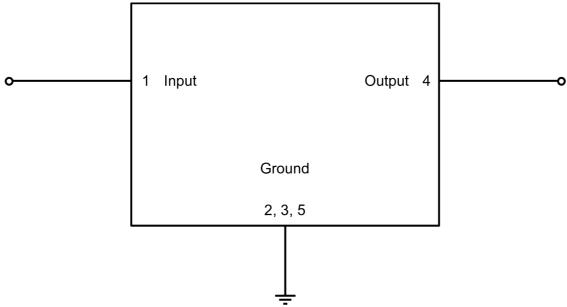


Figure 3: Schematic of matching circuit. No external matching components required.



B9621 **SAW** components

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#### **Characteristics**

Temperature range for specification = −10 °C ... +85 °C

 $T_{ ext{SPEC}} \ Z_{ ext{IN}} \ Z_{ ext{OUT}}$ Input terminating impedance = 50 Ω Output terminating impedance = 50 Ω

Characteristics			$\begin{array}{c} \textbf{min.} \\ \textbf{for } \textit{T}_{\text{SPEC}} \end{array}$	<b>typ.</b> @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency		f <sub>C</sub>		1582.47	_	MHz
Maximum insertion attenuation		$\boldsymbol{\alpha}_{\text{max}}$				
	1559.052 1563.144 MHz		_	1.4	1.9	dB
	1574.42 1576.42 MHz		_	1.0	1.4	dB
	1597.55 1605.89 MHz		_	1.4	1.9	dB
Maximum VSWR		VSWR <sub>max</sub>				
@ input port	1559.052 1563.144 MHz		_	1.8	2.2	
	1574.42 1576.42 MHz		_	1.2	1.8	
	1597.55 1605.89 MHz		_	1.6	2.0	
@ output port	1559.052 1563.144 MHz		_	1.8	2.2	
	1574.42 1576.42 MHz		_	1.2	1.8	
	1597.55 1605.89 MHz		_	1.5	2.0	
Maximum error vector magnitude		EVM <sub>max</sub> 1)				
	1561.452 1603.49 MHz		_	1.0	2.0	%
Minimum attenuation		$\boldsymbol{\alpha}_{\text{min}}$				
	10 960 MHz		45	49	_	dB
	960 1463 MHz		36	45	_	dB
	1710 1785 MHz		33	42	_	dB
	1785 1990 MHz		32	41	_	dB
	1990 2280 MHz		34	39	_	dB
	2280 2400 MHz		38	51	_	dB
	2400 2500 MHz		40	54	_	dB
	2500 2700 MHz		40	54	_	dB
	2700 3000 MHz		40	58	_	dB
	3000 6000 MHz		25	39	_	dB
Group delay ripple		$\Delta  au_{var}$				
	1597.55 1605.89 MHz		_	4.0	16	ns

Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



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#### 7 **Maximum ratings**

Operable temperature	T <sub>OP</sub> = -40 °C +95 °C	
Storage temperature	T <sub>STG</sub> <sup>1)</sup> = -40 °C +95 °C	
DC voltage	$ V_{DC} ^{2} = 0 \text{ V (max.)}$	
ESD voltage		
	$V_{\rm ESD}^{3)} = 50 \text{ V (max.)}$	Machine model.
	$V_{ESD}^{4)} = 225 \text{ V (max.)}$	Human body model.
Input power	P <sub>IN</sub>	
@ input port: 777 915 MHz	28 dBm <sup>5)</sup>	GSM signal duty cycle 1:8 for 10000 h @ 55 °C.
@ input port: 1710 2200 MHz	28 dBm <sup>5)</sup>	GSM signal duty cycle 1:8 for 10000 h @ 55 °C.

Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.

<sup>2)</sup> In case of applied DC voltage blocking capacitors are mandatory.

<sup>3)</sup> 

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse. 4)

Expected Lifetime according to accelerated power durability simulation and wear out models.



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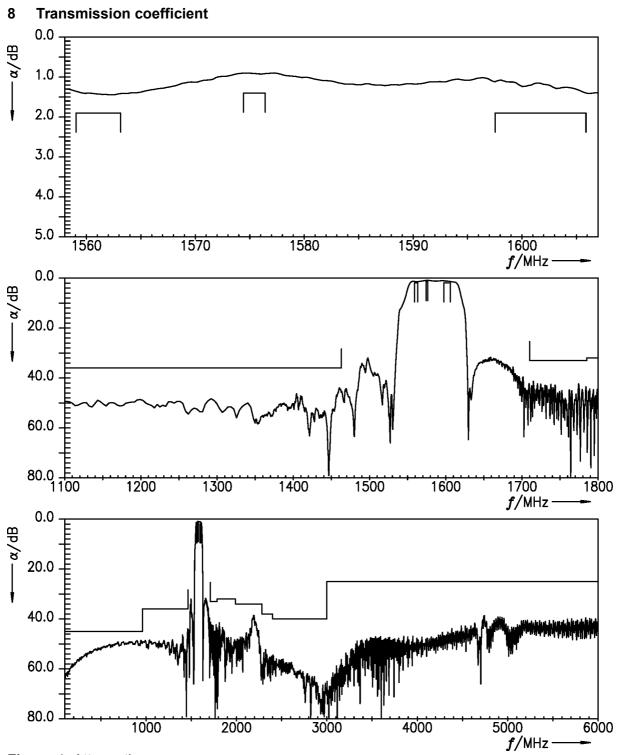


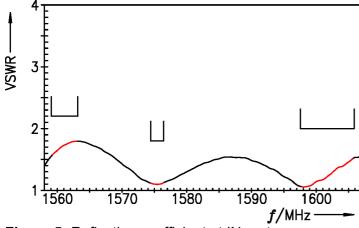
Figure 4: Attenuation.



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#### 9 Reflection coefficients



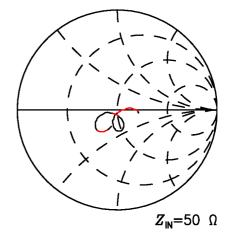
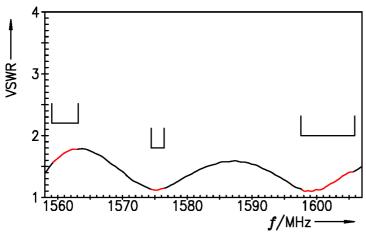


Figure 5: Reflection coefficient at IN port.



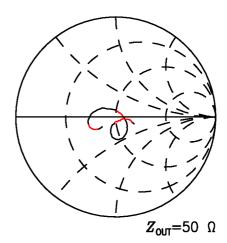


Figure 6: Reflection coefficient at OUT port.





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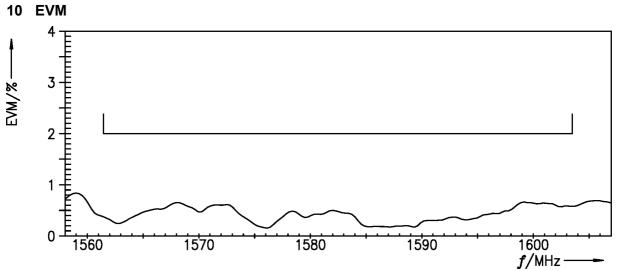


Figure 7: Error vector magnitude.

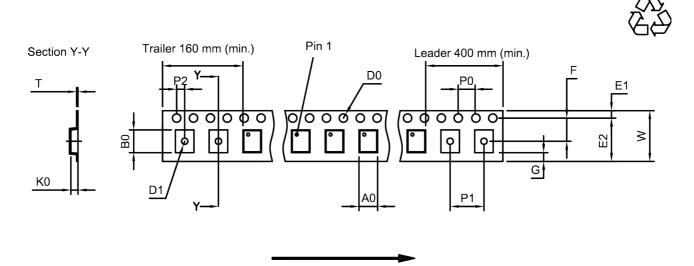


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#### 11 Packing material

### 11.1 Tape



User direction of unreeling

Figure 8: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A <sub>0</sub>	1.27±0.05 mm	E	6.25 mm (min.)	P <sub>1</sub>	4.0±0.1 mm
B <sub>0</sub>	1.57±0.05 mm	F	3.5±0.05 mm	P <sub>2</sub>	2.0±0.05 mm
$D_0$	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.25±0.03 mm
D <sub>1</sub>	0.5±0.1 mm	K	0.62±0.05 mm	W	8.0+0.3/-0.1 mm
E <sub>1</sub>	1.75±0.1 mm	P	4.0±0.1 mm		

Table 1: Tape dimensions.



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#### 11.2 Reel with diameter of 180 mm

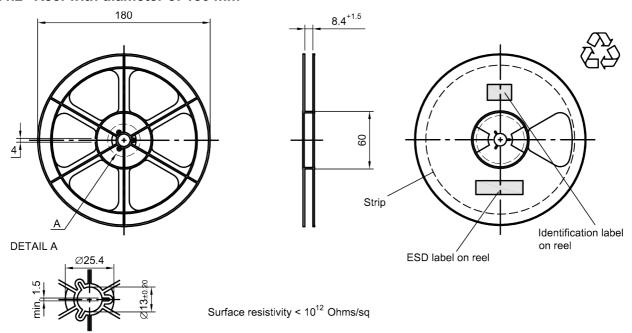


Figure 9: Drawing of reel (first-angle projection) with diameter of 180 mm.

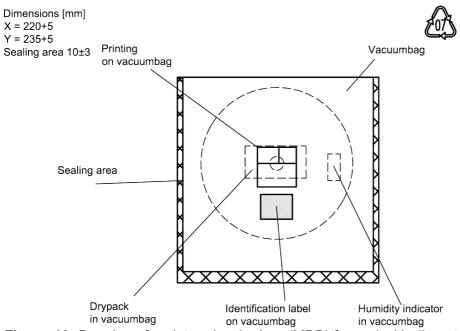


Figure 10: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.



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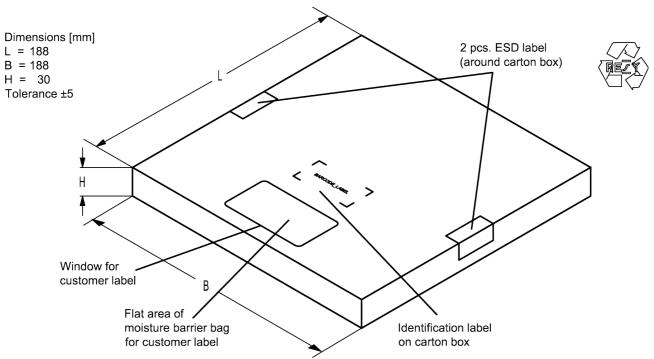


Figure 11: Drawing of folding box for reel with diameter of 180 mm.



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#### 12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

#### ■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x 32<sup>2</sup> + 6 x 32<sup>1</sup> + 18 (=J) x 32<sup>0</sup> = 1234

The BASE32 code for product type B9621 is 9CN.

#### ■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345  $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$  12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	Α	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	Α	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	Е	38	r
15	F	39	t
16	G	40	V
17	Н	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	Р		

Adopted BASE47 code for lot number

**Table 2:** Lists for encoding and decoding of marking.



SAW components	B9621
SAW filter	1582.47 MHz

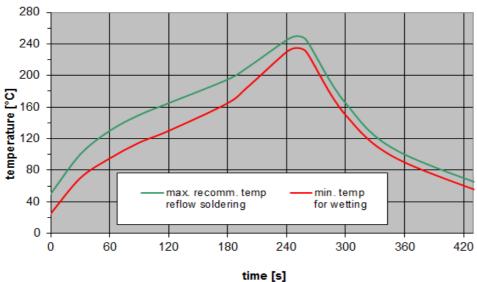
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#### 13 Soldering profile

The recommended soldering process is in accordance with IEC  $60068-2-58-3^{rd}$  edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature $T_{\text{peak}}$	250 °C +0/-5 °C
wetting temperature T <sub>min</sub>	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 12:** Recommended reflow profile for convection and infrared soldering – lead-free solder.



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#### 14 Annotations

#### 14.1 Matching coils

See TDK inductor pdf-catalog <a href="http://www.tdk.co.jp/tefe02/coil.htm#aname1">http://www.tdk.co.jp/tefe02/coil.htm#aname1</a> and Data Library for circuit simulation <a href="http://www.tdk.co.jp/etvcl/index.htm">http://www.tdk.co.jp/etvcl/index.htm</a>.

#### 14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

### 14.4 Ordering codes and packing units

Ordering code	Packing unit
B39162B9621P810	5000 pcs

Table 4: Ordering codes and packing units.



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#### 15 Cautions and warnings

#### 15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <a href="https://www.rf360jv.com/orderingcodes">www.rf360jv.com/orderingcodes</a>.

#### 15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

#### 15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

#### 15.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### **Dimensions**

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

#### **Projection method**

Unless otherwise specified first-angle projection is applied.



#### Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
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- 3. The warnings, cautions and product-specific notes must be observed.
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- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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